



566.43481VC5

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicants: N. FUKUTOMI, et al.  
Application No.: 10/705,706  
Filed: November 10, 2003  
For: FABRICATION PROCESS OF SEMICONDUCTOR  
PACKAGE AND SEMICONDUCTOR PACKAGE  
Group Art Unit: 2813  
Examiner: TBD

**INFORMATION DISCLOSURE STATEMENT**  
**UNDER 37 CFR § 1.97 & § 1.98**

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

July 9, 2004

Sir:

Pursuant to Applicants' duty of disclosure, enclosed please find a copy of a document cited in an Office Action mailed May 13, 2004 in copending Application No. 10/042,408, filed January 8, 2002, which is a related application to the above-identified application. Also enclosed is a Form, substantially equivalent to Form PTO-1449, listing the enclosed document.

This Information Disclosure Statement is being submitted prior to a first Office Action on the merits in the above-identified application. Accordingly, requirements of 37 CFR § 1.97(b) are satisfied.

In any event, the following Statement is made under 37 CFR § 1.97(e):

No item of information contained in this Information  
Disclosure Statement was cited in a communication from a

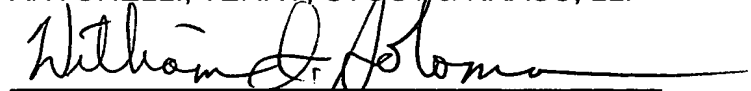
foreign patent office in a counterpart foreign application, and,  
to the knowledge of the undersigned, no item of information  
contained in this Information Disclosure Statement was  
known to any individual designated in 37 CFR § 1.56(c),  
more than three months prior to the filing of this Information  
Disclosure Statement.

In view of the foregoing, it is respectfully submitted that all applicable  
requirements of 37 CFR § 1.97 and § 1.98 have been satisfied, in connection with  
the document listed on the enclosed Form. Accordingly, consideration of the listed  
document, upon examination of the above-identified application, is respectfully  
requested.

Please charge any shortage in the fees due in connection with the filing of this  
paper, including extension of time fees, to Deposit Account No. 01-2135  
(referencing docket no. 566.43481VC5), and please credit any excess fees to such  
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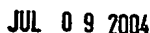
Respectfully submitted,

ANTONELLI, TERRY, STOUT & KRAUS, LLP

A handwritten signature in black ink, appearing to read "William I. Solomon", written over a horizontal line.

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Approved for use through 10/31/2002. OMB 0651-0031

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## INFORMATION DISCLOSURE STATEMENT BY APPLICANT

*(use as many sheets as necessary)*

U.S. PATENT DOCUMENTS

## FOREIGN PATENT DOCUMENTS

OTHER PRIOR ART—NON PATENT LITERATURE DOCUMENTS

**Examiner  
Signature**

Date Considered

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**Burden Hour Statement:** This form is estimated to take 2.0 hours to complete. Time will vary depending upon the needs of the individual case. Any comments on the amount of time you are required to complete this form should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, Washington, DC 20231. **DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO:** Assistant Commissioner for Patents, Washington, DC 20231.